

36V Low Current Consumption 250mA CMOS Voltage Regulator

■ INTRODUCTION

The HG1305 series are a group of positive voltage regulators manufactured by CMOS technologies with low power consumption and low dropout voltage, which provide large output currents even when the difference of the input-output voltage is small. The HG1305 series can deliver 250mA output current and allow an input voltage as high as 36V. The series are very suitable for the battery-powered equipments, such as RF applications and other systems requiring a quiet voltage source.

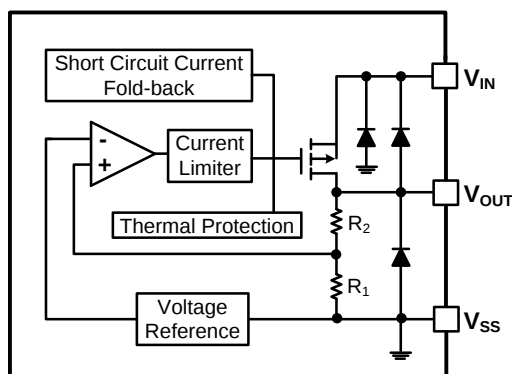
■ FEATURES

- Low Quiescent Current: 2 μ A
- Operating Voltage Range: 2.5V~36V
- Output Current: 250mA
- Low Dropout Voltage:
600mV@100mA($V_{OUT}=3.3V$)
- Output Voltage: 2.1~ 12V
- High Accuracy: $\pm 2\%/\pm 1\%$ (Typ.)
- High Power Supply Rejection Ratio:
70dB@1kHz
- Low Output Noise:
27x V_{OUT} μV_{RMS} (10Hz~100kHz)
- Excellent Line and Load Transient Response
- Built-in Current Limiter, Short-Circuit Protection
- Over-Temperature Protection
- Stable with Ceramic or Tantalum Capacitor

■ APPLICATIONS

- Cordless Phones
- Radio control systems
- Laptop, Palmtops and PDAs
- Single-lens reflex DSC
- PC peripherals with memory
- Wireless Communication Equipments
- Portable Audio Video Equipments
- Car Navigation Systems
- LAN Cards
- Ultra Low Power Microcontrolle

■ BLOCK DIAGRAM



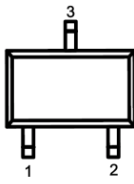
■ ORDER INFORMATION

HG1305①②③④⑤⑥

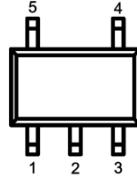
DESIGNATOR	SYMBOL	DESCRIPTION
①	A	Standard
②③④	Integer	Output Voltage e.g.12.0V=②:1, ③:2, ④:0
⑤	M/MC/MY	Package:SOT-23-3
	MF/MR	Package:SOT-23-5
	P/PT/PL	Package:SOT-89-3
	T/TA/TB	Package:TO-92
	ES	Package:SOP8-PP
⑥	-	2% Accuracy
	1	1% Accuracy

■ PIN CONFIGURATION

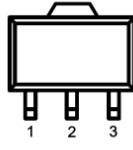
SOT-23-3



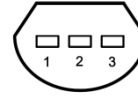
SOT-23-5



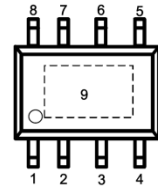
SOT-89-3



TO-92



SOP8-PP



PIN NUMBER									PIN NAME	FUNCTION
SOT-23-3			SOT-89-3			TO-92				
M	MC	MY	P	PT	PL	T	TA	TB		
1	3	3	1	2	2	1	2	2	V _{SS}	Ground
2	2	1	3	1	3	3	3	1	V _{OUT}	Output
3	1	2	2	3	1	2	1	3	V _{IN}	Power input

SOT-23-5

PIN NUMBER		PIN NAME	FUNCTION
MF	MR		
1	2	V_{IN}	Power Input
2	1	V_{SS}	Ground
3/4	4/5	NC	No Connection
5	3	V_{OUT}	Output

SOP8-PP

PIN NUMBER		PIN NAME	FUNCTION
ES			
1		V _{OUT}	Output
5		V _{SS}	Ground
8,9		V _{IN}	Power Input
2,3,4,6,7		NC	No Connection

■ ABSOLUTE MAXIMUM RATINGS⁽¹⁾

(Unless otherwise specified, $T_A=25^{\circ}\text{C}$)

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage ⁽²⁾		V_{IN}	-0.3~40	V
Output Voltage ⁽²⁾		V_{OUT}	-0.3~13	V
Power Dissipation	SOT-23	P_D	400	mW
	SOT-89		600	mW
	TO-92		500	mW
	SOP8-PP		1200	mW
Operating Junction Temperature Range ⁽³⁾		T_j	150	$^{\circ}\text{C}$
Storage Temperature		T_{stg}	-65~150	$^{\circ}\text{C}$
Lead Temperature(Soldering, 10 sec)		T_{solder}	260	$^{\circ}\text{C}$

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network ground terminal.

(3) This IC includes over temperature protection that is intended to protect the device during momentary overload. Junction temperature will exceed 125°C when over temperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	MIN.	NOM.	MAX.	UNITS
Supply voltage at V_{IN}	2.5		36	V
Operating junction temperature range, T_j	-40		125	$^{\circ}\text{C}$
Operating free air temperature range, T_A	-40		85	$^{\circ}\text{C}$

■ ELECTRICAL CHARACTERISTICS

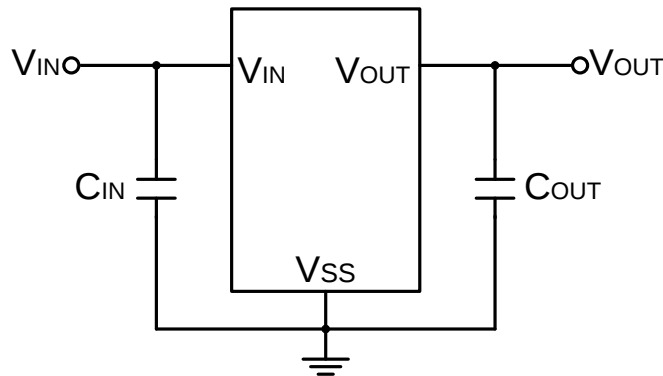
HG1305 Series ($V_{IN}=V_{OUT}+2V$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^\circ C$, Unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP. ⁽⁴⁾	MAX.	UNITS
Input Voltage	V_{IN}		2.5	—	36	V
Output Voltage Range	V_{OUT}		2.1	—	12	V
DC Output Accuracy		$I_{OUT}=10mA$	-2	—	2	%
			-1	—	1	%
Dropout Voltage	$V_{dif}^{(5)}$	$I_{OUT}=100mA, V_{OUT}=3.3V$	—	600	—	mV
Supply Current	I_{SS}	$I_{OUT}=0A$, $2.1V \leq V_{OUT} \leq 5.0V$	—	2	5	μA
		$I_{OUT}=0A$, $5.0V < V_{OUT} \leq 12.0V$	-	5	10	μA
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT} \times \Delta V_{IN}}$	$I_{OUT}=10mA$ $V_{OUT}+1V \leq V_{IN} \leq 36V$	—	0.01	0.3	%/V
Load Regulation	ΔV_{OUT}	$V_{IN}=V_{OUT}+2V$, $1mA \leq I_{OUT} \leq 100mA$	—	10	—	mV
Temperature Coefficient	$\frac{\Delta V_{OUT}}{V_{OUT} \times \Delta T_A}$	$I_{OUT}=40mA$, $-40^\circ C < T_A < 85^\circ C$		50		ppm/ $^\circ C$
Output Current Limit	I_{LIM}	$V_{OUT}=0.5 \times V_{OUT(Normal)}$		350		mA
Short Current	I_{SHORT}	$V_{OUT}=V_{SS}$	—	25	—	mA
Power Supply Rejection Ratio	PSRR	$I_{OUT}=50mA$	100Hz	80		dB
			1kHz	70	—	
			10kHz	60	—	
			100kHz	50	—	
Output Noise Voltage	V_{ON}	BW=10Hz to 100kHz	—	$27 \times V_{OUT}$	—	μV_{RMS}
Thermal Shutdown Temperature	T_{SD}	$I_{LOAD}=30mA$	—	160	—	$^\circ C$
Thermal Shutdown Hysteresis	ΔT_{SD}	—	—	20	—	$^\circ C$

(4) Typical numbers are at $25^\circ C$ and represent the most likely norm.

(5) V_{dif} : The Difference Of Output Voltage And Input Voltage When Input Voltage Is Decreased Gradually Till Output Voltage Equals To 98% Of V_{OUT} (E).

■ TYPICAL APPLICATION CIRCUIT



External Components List

Symbol	Description
C_{IN}	1.0 μ F or more, 10 μ F is recommended
C_{OUT}	1.0 μ F or more, 10 μ F is recommended

■ APPLICATION INFORMATION

● Selection of Input/ Output Capacitors

Phase compensation is provided to secure operation even when the load current is varied. For this purpose, use a 1.0 μ F or more output capacitor (C_{OUT}) with good frequency characteristics and proper ESR (Equivalent Series Resistance). Connect a 1.0 μ F or more input capacitor (C_{IN}) between the V_{IN} pin and the V_{SS} pin as close as possible to the pins. The value of the output overshoot or undershoot transient response varies depending on the value of the output capacitor.

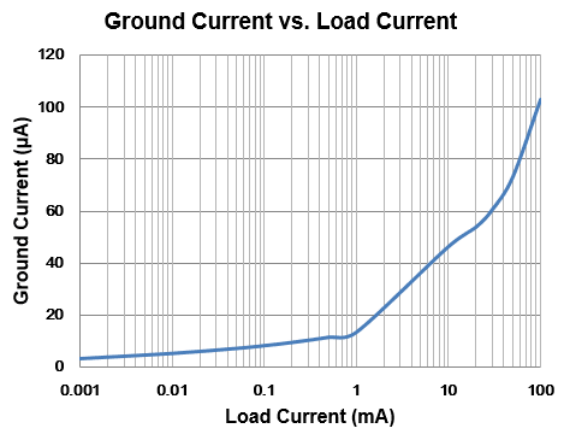
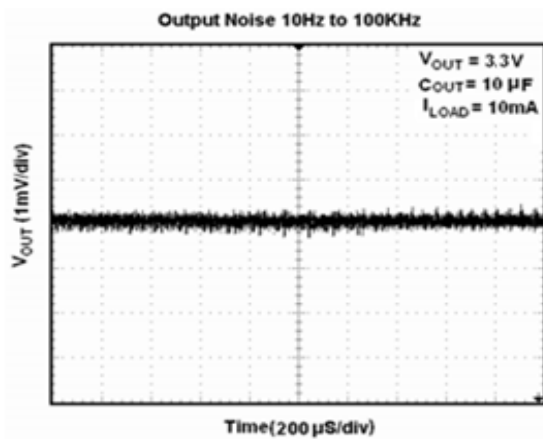
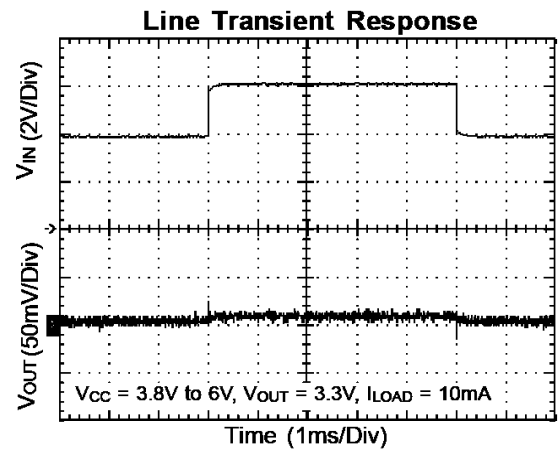
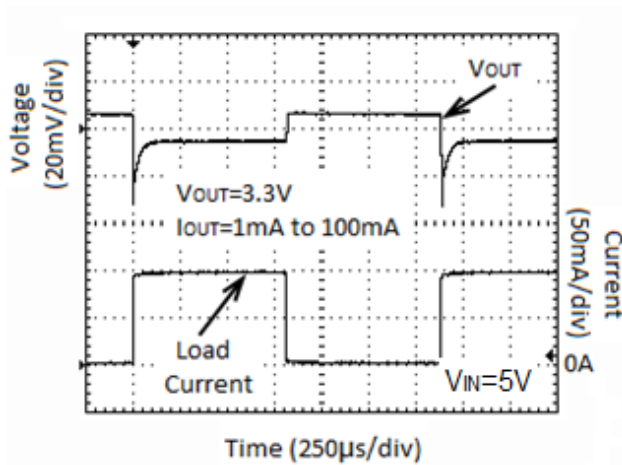
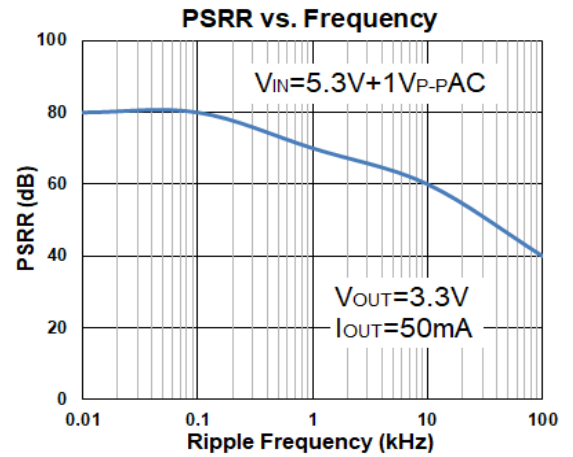
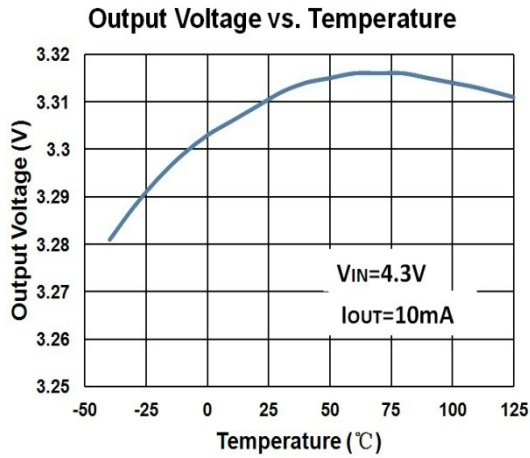
When selecting the output capacitor, perform sufficient evaluation, including evaluation of temperature characteristics, on the actual device.

In the design of portable devices the ceramic capacitors are often chosen because of their small size, low equivalent series resistance (ESR) and high RMS current capability. Also, designers have been looking to ceramic capacitors due to shortages of tantalum capacitors.

Unfortunately, using ceramic capacitors for input filtering can cause problems. Applying a voltage step to a ceramic capacitor causes a large current surge that stores energy in the inductances of the power leads. A large voltage spike is created when the stored energy is transferred from these inductances into the ceramic capacitor. These voltage spikes can easily be twice the amplitude of the input voltage step.

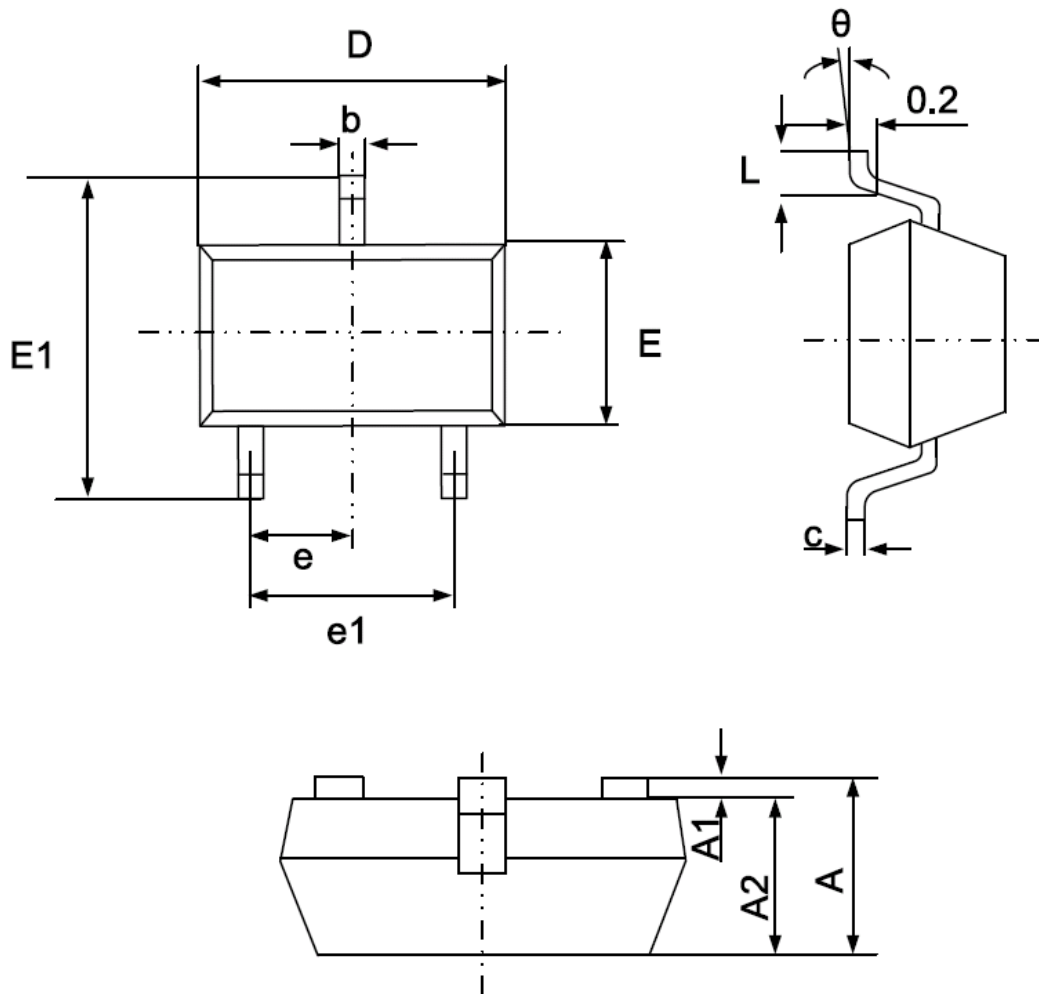
Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors (MLCC). Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the LDO input to a live power source. Adding a 3 Ω resistor in series with an X5R ceramic capacitor will minimize start-up voltage transients.

■ TYPICAL PERFORMANCE CHARACTERISTICS



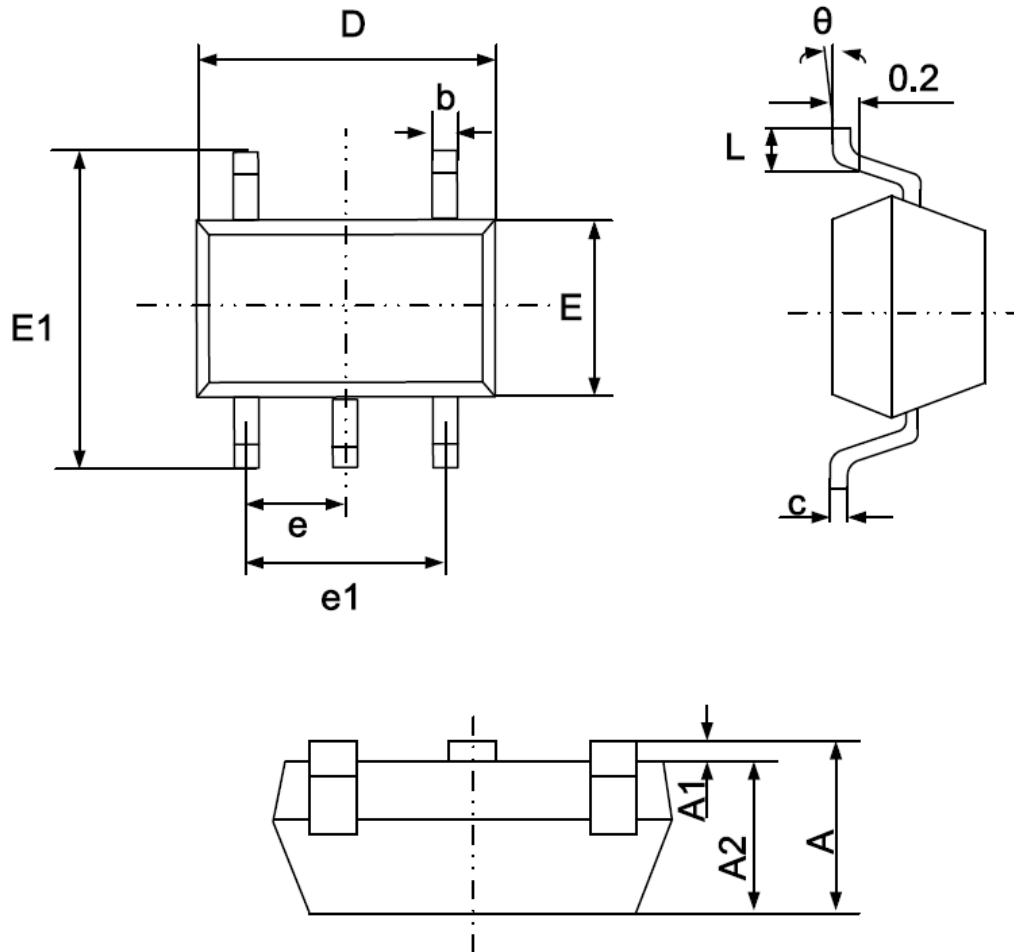
■ PACKAGING INFORMATION

● SOT-23-3 PACKAGE OUTLINE DIMENSIONS



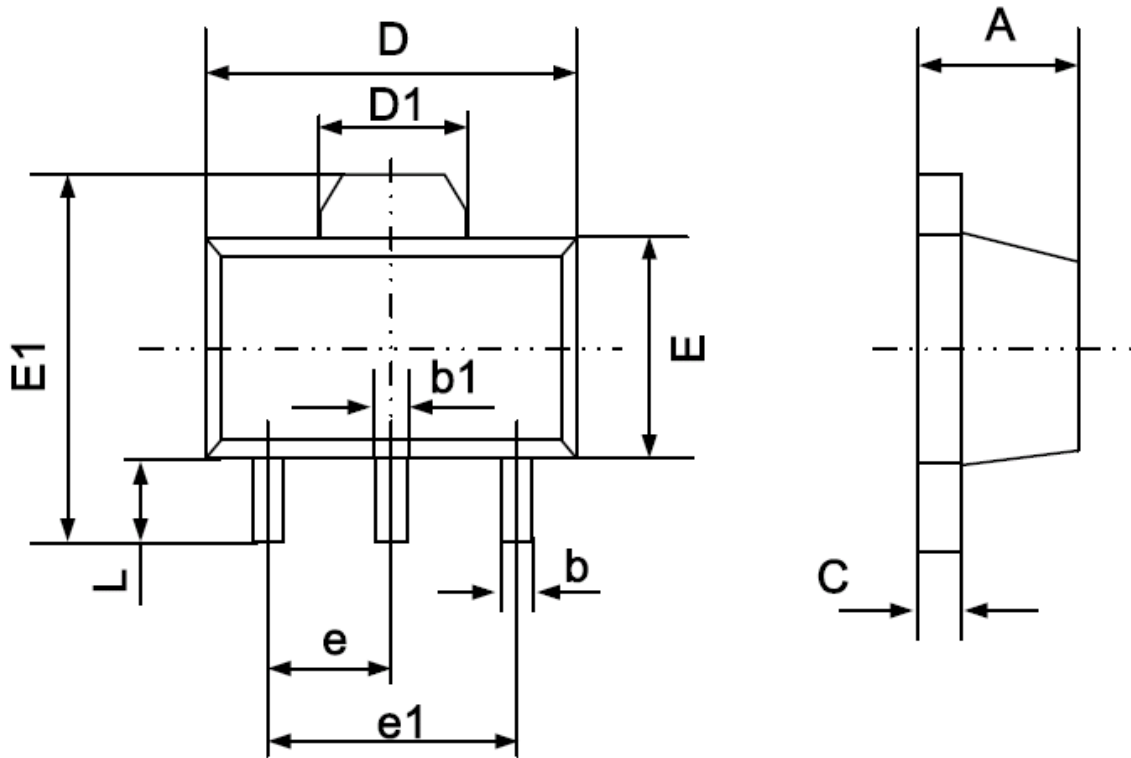
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

● SOT-23-5 PACKAGE OUTLINE DIMENSIONS



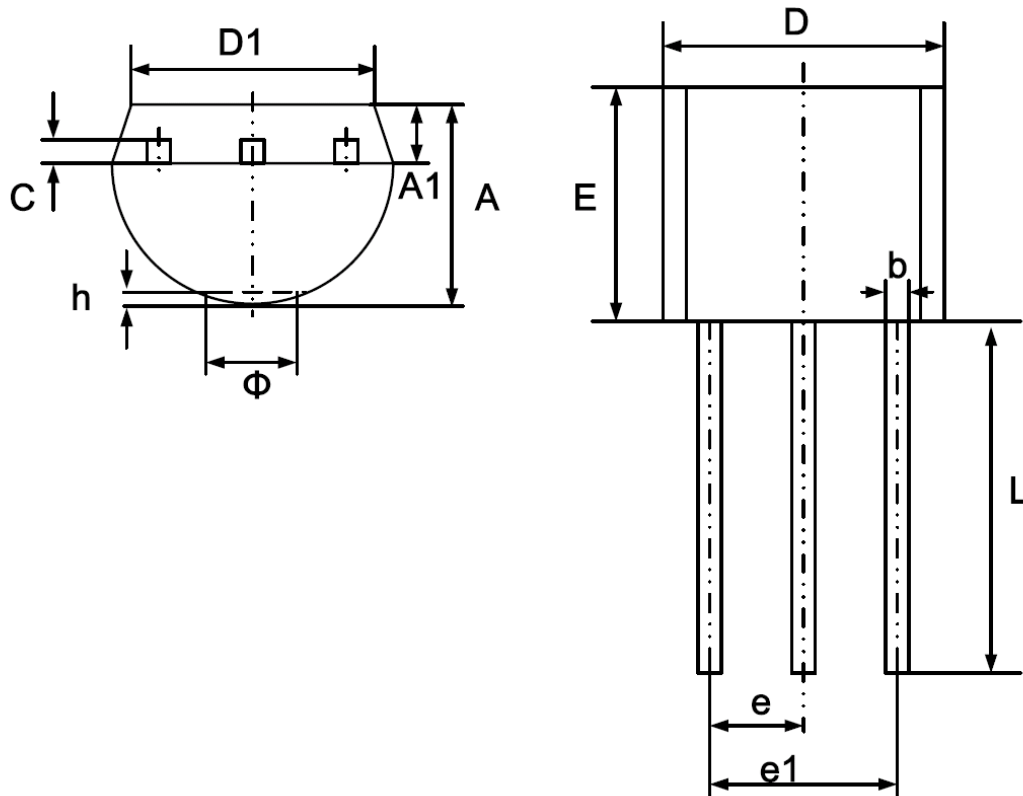
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

- SOT-89-3 PACKAGE OUTLINE DIMENSIONS



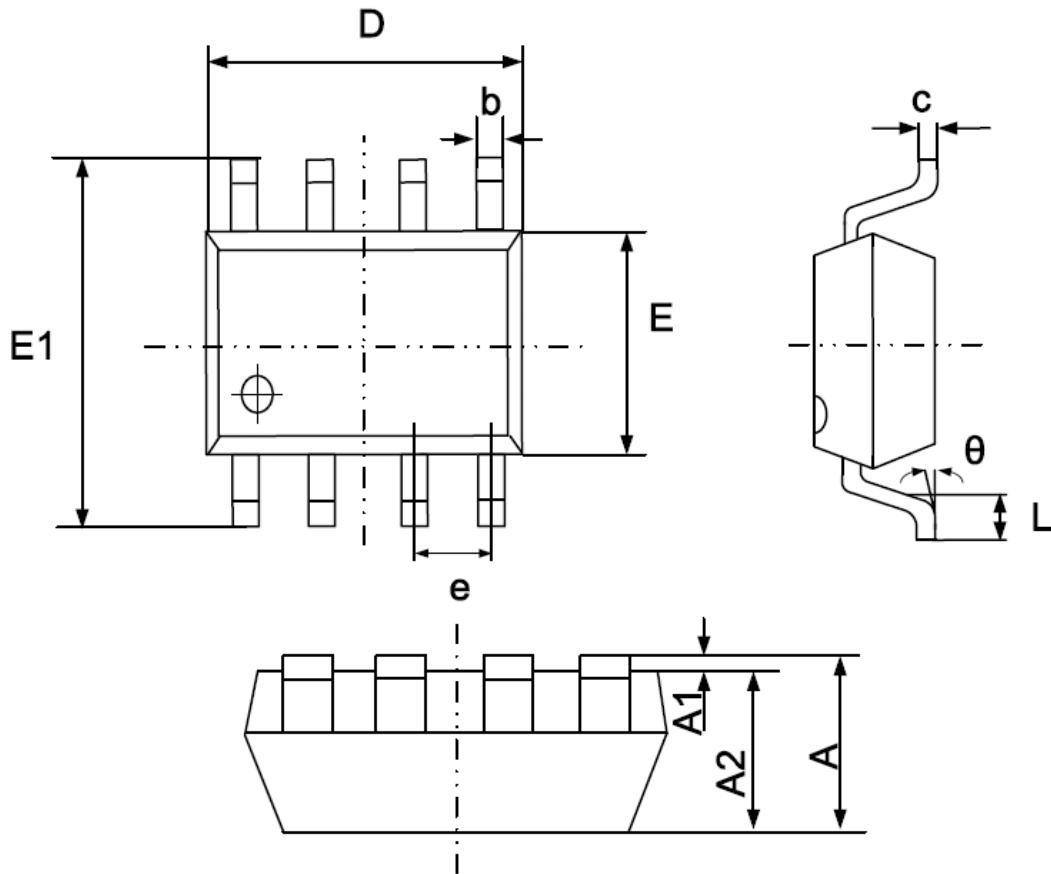
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060 TYP	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047

● TO-92 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
c	0.360	0.510	0.014	0.020
D	4.400	4.700	0.173	0.185
D1	3.430		0.135	
E	4.300	4.700	0.169	0.185
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
Φ		1.600		0.063
h	0.000	0.380	0.000	0.015

● SOP8-PP PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
D1	3.100	3.500	0.122	0.137
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
E2	2.200	2.600	0.086	0.102
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°